

### **Description**

The WPE0521P is designed with WPMTEK

Punch-Through process TVS technology to protect voltage sensitive components from ESD. Excellent clamping capability, low leakage, and fast response time provide best in class protection on designs that are exposed to ESD. Because of its small size, it is suited for use in cellular phones, MP3 players, digital cameras and many other portable applications where board space comes at a premium. Also because of its low capacitance, it is suited for use in high frequency designs such as USB 2.0 high speed, USB 3.0 super speed, VGA, DVI, HDMI, eSATA and other high speed line applications. It has been specifically designed to protect sensitive components which are connected to data and transmission lines from overvoltage caused by ESD(electrostatic discharge), and EFT (electrical fast transients).

#### **Features**

Ultra small package: 1.0x0.6x0.5mmUltra low capacitance: 0.3pF typical

■ No insertion loss to 3.0GHz

■ Working voltage: 5V

Low clamping voltage

2-pin leadless package

Complies with following standards:

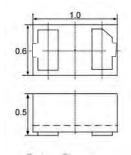
- IEC 61000-4-2 (ESD) immunity test

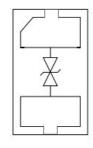
Air discharge: ±20kV Contact discharge: ±20kV

- IEC61000-4-5 (Lightning) 4A (8/20µs)

■ RoHS Compliant

## **Dimensions & Symbol** (Unit: mm Max)





#### **Mechanical Characteristics**

■ Package: DFN1006-2L (1.0×0.6×0.5mm)

■ Lead Finish: NiPdAu

Case Material: "Green" Molding Compound.

■ Moisture Sensitivity: Level 3 per J-STD-020

Terminal Connections: See Diagram Below

Marking Information: See Below

## **Applications**

■ High Speed Line :USB1.0/2.0/3.0/3.1, VGA, DVI.SDI

High Definition Multi-Media Interface (HDMI1.3/1.4/2.0)

Serial and Parallel Ports

■ Notebooks, Desktops, Servers

Peripherals

Cellular handsets and accessories

Portable instrumentation

### **Marking information**

21

Details marking code reference specification of approval

## **Ordering Information**

ging Reel Size	
e & Reel 7 inch	
	re & Reel 7 inch



## **Absolute maximum ratings** (T<sub>A</sub>=25°C, RH=45%-75%, unless otherwise noted)

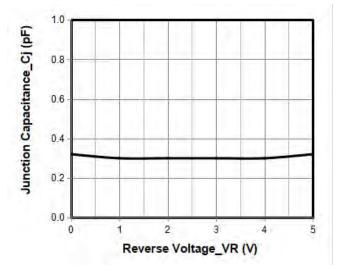
Parameter	Symbol	Value	Unit	
Peak Pulse Power (tp=8/20µs waveform)	P <sub>ppp</sub>	100	W	
ESD per IEC 61000-4-2 (Air)		±20		
ESD per IEC 61000-4-2 (Contact)	VESD	±20	kV	
Operating Temperature Range	TJ	-55 to +125	°C	
Storage Temperature Range	Tstg	−55 to +150	°C	

# Electrical characteristics (T<sub>A</sub>=25 $^{\circ}$ C)

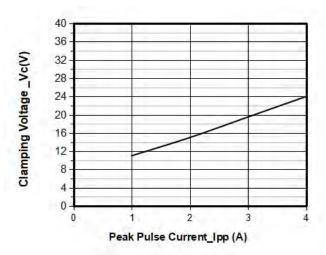
Parameter	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Working Voltage	V <sub>RWM</sub>			5	V	
Breakdown Voltage	VBR	6		10	V	IT = 1mA
Reverse Leakage Current	I <sub>R</sub>			0.2	μA	VRWM = 5.0 V
Clamping Voltage	Vc			12	V	IPP = 1A (8 x 20µs pulse)
Clamping Voltage	Vc			25	V	IPP = 4A (8 x 20µs pulse)
Junction Capacitance	Сл		0.3	0.5	pF	VR = 0V, f = 1MHz



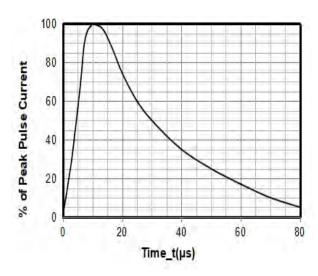
## Typical Performance Characteristics (TA=25°C unless otherwise Specified)



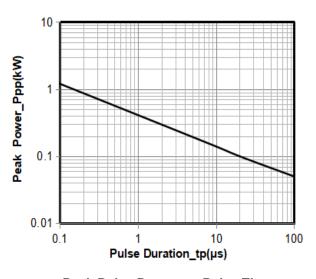
Junction Capacitance vs. Reverse Voltage



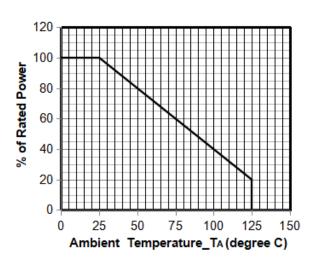
Clamping Voltage vs. Peak Pulse Current



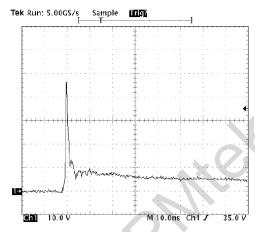
8 X 20µs Pulse Waveform



Peak Pulse Power vs. Pulse Time



**Power Derating Curve** 



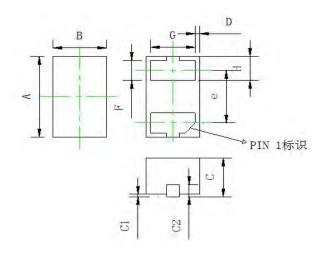
Note: Data is taken with a 10x attenuator

ESD Clamping Voltage

8 kV Contact per IEC61000-4-2

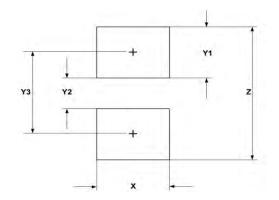


## Package mechanical data



0111 m 01	MILLIMETER			
SYMBOL	MIN	NOM	MAX	
A	0.95	1.00	1.05	
В	0. 55	0.60	0.65	
С	0. 40	0. 45	0. 50	
C1			0.05	
D	0.02	0.05	0. 08	
е	0.65 BSC			
F	0. 20	0. 25	0.30	
G	0.45	0.50	0. 55	
H	0.27	0. 30	0. 33	
C2	0.13	0. 15	0.17	

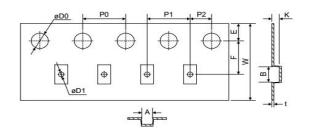
## **Suggested Land Pattern**



	DIMENSIONS		
SYM	MILLIMETERS	INCHES	
Х	0.60	0.024	
Y1	0.50	0.020	
Y2	0.30	0.012	
Y3	0.80	0.032	
Z	1.30	0.052	

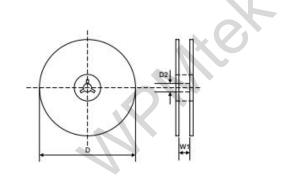
## Tape Specification - DFN1006-2L (mm)

W	8.0±0.1
P1	2.0±0.1
А	0.7±0.05
В	1.15±0.05
К	0.57±0.03



# Reel Specification - DFN1006-2L (mm)

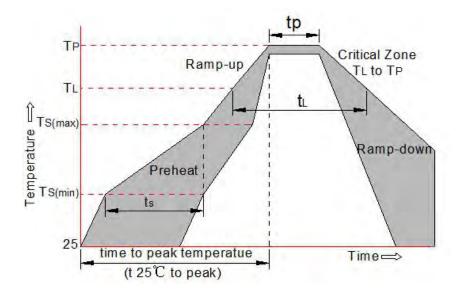
W1	8.6
D	180.0±1.0
D2	24±1.0





## **Soldering parameters**

Reflow Condition		Pb-Free assembly (see FIG.2)
Pre Heat	-Temperature Min (T <sub>s(min)</sub> )	+150℃
	-Temperature Max(T <sub>s(max)</sub> )	+200℃
	-Time (Min to Max) (ts)	60-180 secs.
Average ramp up rate (Liquid us Temp (T <sub>L</sub> ) to peak)		3℃/sec. Max
T <sub>s(max)</sub> to T <sub>L</sub> - Ramp-up Rate		3℃/sec. Max
Reflow	-Temperature(T <sub>L</sub> ) (Liquid us)	+217℃
	-Temperature(t <sub>L</sub> )	60-150 secs.
Peak Temp (T <sub>p</sub> )		+260(+0/-5)°C
Time within 5℃ of actual Peak Temp (t <sub>p</sub> )		30 secs. Max
Ramp-down Rate		6℃/sec. Max
Time 25℃ to Peak Temp (T <sub>P</sub> )		8 min. Max
Do not exceed		+260℃



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